

## TECHNICAL SPEC FOR Ion Implanter

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System Model:

Axcelis 6200AV

- Wafer size? 6 inch
- Wheel type? none
- Wafer tilt? 0/45
- Source (i.e. Bernas or IHC)? bernas
- Extraction system (i.e. dual bellows)? fixed
- Gases? Boron, phosfine
- SDS Gas box? yes
- Max implantation energy (in KeV)? 180
- Max Extraction voltage (in KeV)? 20
- Heat Exchanger? no

- **Orienter type (flat, notched, etc...)? flat**
- **Hydrogen implantation available? no**
- **Number of trays? 1**
- **Load and unload locks: yes**
- **Source extraction alignment jig yes**
- **AMU yes**
- **Beamline column yes**
- **Mechanical clamp: yes**
- **Turbo type? none**
- **PC type:**
- **Cryo type? cti**
- **PFS standard or HD? hd**

